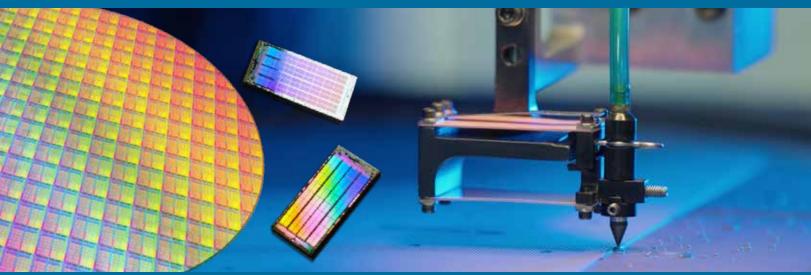


# **Die & Wafer Solutions**

**Products & Services Overview** 



Micross is the largest authorized global supplier of bare die. With 45+ years of experience and the most comprehensive portfolio of end-to-end die/wafer processing capabilities, Micross is uniquely positioned to support your device/system requirements as no one else can.... all from one source.



#### Die Distribution

· World's Largest Franchised Offering of Bare Die & Wafer

#### Wafer Probe

- · Hot & Cold Chuck Temperature Probing
- · Up to 12" Wafer Capacity, Final Test at Wafer Level

### Wafer Bumping & RDL

- · Solder & Gold Bump Available
- · In-House Design Services and Technical Support

### Wafer Mapping / Wafer Inking

- · Conversion Between Industry Formats
- · Inking Using Any Electronic Wafer Map

## Wafer Thinning

Outsourced to Qualified Partners

- · Wafers Thinned Down to 100µm
- · Wafer Sizes up to and Including 12" (300mm)

## Wafer Dicing / Sawing

- ±1µm Tolerance
- · Custom Dicing Plans, Multi-Project Wafers
- · Wafer Sizes up to and Including 12" (300mm)

## Die Plating / Pick & Place

- · Automated, Virtually Contactless Handing of Singulated Die
- · Compatible with All Electronic Wafer Maps
- · Multiple Bin / Grade Die Picking
- · Safe Handling of Sensitive Topside & 3D Features

# Visual Inspection

- · AQL
- · MIL-STD (Commercial, Military, and Aerospace Grades)
- · Inspection via AOI Equipment Available

### **Customized Outputs**

- · Sawn Wafer on Film-Frame and Ring-Frame
- · Waffle Pack or Gel-Pak®
- · Tape-N-Reel

## **Micross Die & Wafer Processing Facilities**

World Class Die & Wafer Processing Operations and Distribution. AS9100 & ISO9001 Certified



Apopka, FL - Die & Wafer Solutions

Wafer Processing & Test, and Die Distribution



Woburn, MA - Micross Express

Die Distribution, Passive Components, Same-Day Service & Vendor Managed Inventory



Norwich, UK - Die & Wafer Solutions

Wafer Processing & Test, and Die Distribution

#### **Check Out Our Line Card!**



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Product Type		Die & Wafer Availability from Leading Semiconductor Manufacturers											
Analog													
Amplifiers	•	•	•	•	•								
Comparators	•	•	•	•	•								
Data Converters	•	•	•	•	•								
Interface	•	•	•	•	•								
Analog Multiplexers	•	•	•	•									
Analog Switches	•	•	•			•							
Power Management													
Voltage References/Regulators	•	•	•	•	•								
Logic													
Logic	•	•	•	•	•								
Memory													
DRAM							•			•			
EEPROM/EPROM			•	•	•								
FLASH				•			•			•			
SRAM, SYNCH/ASYNCH			•	•						•			
Processors													
DSP	•			•									
Microprocessors/Microcontrollers	•	•	•	•									
FPGA/PLD													
FPGA/PLD				•									
Discretes													
Diodes				•	•	•		•	•		•	•	
Standard Rectifiers					•	•		•	•			•	
Voltage Suppressors								•	•			•	
Bipolar Transistors	•			•				•			•		
ECL (Emitter Coupled Logic)				•	•								
IGBT				•	•	•			•			•	
JFET	•				•			•			•		
Power MOSFET				•	•	•		•	•		•	•	
Thyristor						•		•	•			•	
Triac												•	
Resistors						•							
Optoelectronics													
Optoelectronics						•						•	



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